### **EMI Common Mode Choke**



#### **BPPM Series**



#### Overview

An EMI common mode choke (CMC) for power lines is a passive component specifically designed to suppress electromagnetic interference (EMI) in power supply circuits

A full series of common mode choke is designed for excellent noise attenuation with compact sizing for use in wide range of applications. Both standard series and custom designs are available.

#### **Benefits**

- 1. For DC Power Line Common Mode Filter
- 2. Miniature SMD type common mode filter for fully automated assembly
- 3. Wide impedance range ( $70\Omega \sim 3000\Omega$ ) for EMI suppression
- 4. Operating temperature range −40°C ~ 125°C
- 4. Excellent solderability

#### **Applications**

- 1. Networking
- 2. EMI solutions for charger
- 3. Media player, Dashboard

#### **Product Information**

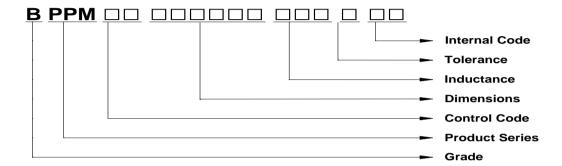
Series	Size Code (JIS/EIA)	Impedance( $\Omega$ )
BPPM	5050/2020 7060/2824 9070/3628	70 ~ 3000
	1211/4844 1513/6052 4850/1920	







- 1 Scope: This specification applies to the Pb Free DC Power Line Common Mode Filter
- 2 Part Numbering:



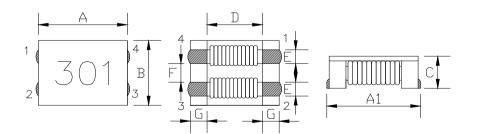
## 3 Rating:

Operating Temperature: - 40°C ~ 125°C(Including self - temperature rise) Storage Temperature: (on tape & reel): -20°C to +40°C; 75% RH max.

## 4 Standard Testing Condition:

Unless otherwise specified		In case of doubt
Temperature	Ordinary Temperature(15 to 35°ℂ)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

### 5 Configuration and Dimensions and Unit Weight:



A: 9.0±0.5 mm A1: 9.5±0.5 mm B: 7.0±0.5 mm C: 4.8 Max. mm D: 5.6 Typ. mm E: 1.5±0.2 mm F: 2.0±0.2 mm G: 1.7±0.2 mm

#### Net Weight (grms)

Marking XXX

Marking color:Black

SIZE CODE	Net Weight (grms)	
090748	0.82(Typ.)	

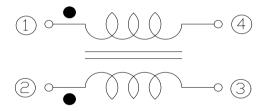
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## 6 Electrical Characteristics:

PT/NO.	Impedance(Ω) at 100MHz		Resistance RDC(Ω)	Rated Current	Insulation Resistance	Rated Voltage
	Min.	Тур.	Max.(1 line)	(A) Max.	(MΩ) Min.	(V)Max.
BPPM00090748301X00	225	300	6m	6	10	125
BPPM00090748501X00	450	600	8m	5.5	10	125
BPPM00090748701X00	500	700	10m	5.0	10	125
BPPM00090748102X00	750	1000	13m	4.0	10	125
BPPM00090748152X00	1100	1500	18m	3.5	10	125
BPPM00090748222X00	1700	2200	60m	2.5	10	125
BPPM00090748272X00	2000	2700	86m	2.0	10	125

### **CIRCUIT DIAGRAM**



#### NOTE:

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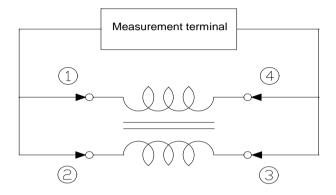
<sup>1.</sup>Rated DC Current: Based on temperature rise (△T: 40°C Typ.)



## 6 Electrical Characteristics:

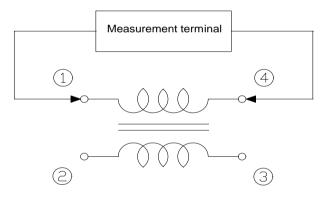
#### (6)-1 Impedance

Measured by HP4291B RF Impedance Analyzer.



#### (6)-2 DC Resistance

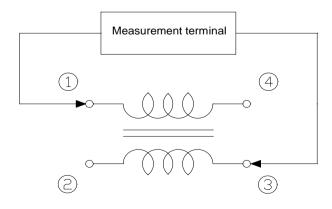
Measured by Chroma 16502 milliohm meter.



#### (6)-3 Insulation Resistance

Measured by Chroma 19073

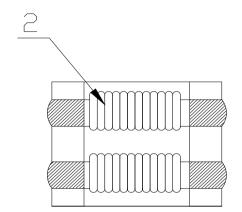
Measurement voltage: 50V, Measurement time: 3 sec.

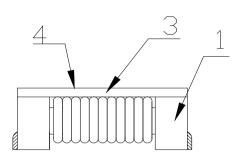


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# 6 6.1 Construction:





### 6.2 Material List:

NO.	ITEM	DESCRIPTION & TYPE
1	CORE	FERRITE
2	Wire	Magnet Wire
3	Cover	Mayler
4	Marking	INK



### MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Solder ability	The product shall be connected to the test	Apply cream solder to the printed circuit board .
	circuit board by the fillet (the height is 0.2mm).	Refer to clause 8 for Reflow profile.
Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	Temperature  Ramp up: Ramp down:  3°C/sec. max.  Ramp down:  6°C/sec. max.  260°C  217°C  160°C  25°C  Preheat   Freheat   150-200°C  60-120 sec.  60-150 sec.
Terminal strength	The terminal electrode and the ferrite must not damaged.	Note: 1. Re-Flow Possible times:within 2 times 2. Nitrogen adopted is recommended while in re-flow Solder a chip to test substrate, and then laterally apply a load 9.8N in the arrow direction.
		Printed circuit board
Strength on PC board	The terminal electrode and the ferrite must	Solder a chip to test substrate and then apply a load.
bending	not damaged.	Test board:FR4 100×40×1mm Fall speed:1mm/sec.  Dimensions in mm
High	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test circuit
temperature	Insulation resistance and DC resistance on the	board,the test shall be done.
resistance	specification(refer to clause 2-1) shall be met.	Measurement : After placing for 24 hours min.
	The terminal electrode and the ferrite must not	Temperature : +125±2℃
	damaged.	Applied voltage : Rated voltage
		Applied current : Rated current
		Testing time : 500±12 hours

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### MECHANICAL

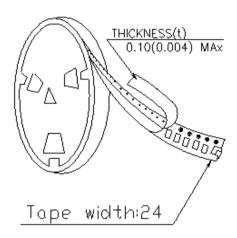
TEST ITEM	SPECIFICATION	TEST DETAILS
Humidity	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test circuit
resistance	Insulation resistance and DC resistance on the	board,the test shall be done.
	specification(refer to clause 2-1) shall be met.	Measurement : After placing for 24 hours min.
	The terminal electrode and the ferrite must not	Temperature : +60±2℃ , Humidity : 90 to 95 %RH
	damaged.	Applied voltage : Rated voltage
		Applied current : Rated current
		Testing time : 500±12 hours
Thermal shock	Impedance:Within±20% of the initial value. Insulation resistance and DC resistance on the	1 cycle   30 min.   125°C   30 sed
	specification(refer to clause 2-1) shall be met. The terminal electrode and the ferrite must not damaged.	-40°C + 30 min.
		Testing Time:100 cycle
Low	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test
temperature	Insulation resistance and DC resistance on the	circuit board,the test shall be done.
storage	specification(refer to clause 2-1) shall be met.	Measurement : After placing for 24 hours min.
	The terminal electrode and the ferrite must	Temperature : -40±2℃
	not damaged.	Testing time : 500±12 hours
Vibration	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test circuit
	Insulation resistance and DC resistance on	board,the test shall be done.
	the specification(refer to clause 2-1)	Frequency : 10 to 55 Hz
	shall be met.	Amplitude : 1.52 mm
	The terminal electrode and the ferrite must	Dimension and times : X ,Y and Z directions
	not damaged.	for 2 hours each.
Solderability	New solder More than 75%	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated
		over the whole of the sample before hard, the sample shall
		then be preheated for about 2 minutes in a temperature
		of 130∼150℃ and after it has been immersed to a depth
		0.5mm below for 3±0.2 seconds fully in molten solder
		M705 with a temperature of 245±2℃. More than 75% of the
		electrode sections shall be couered
		with new solder smoothly when the sample is taken out

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## 7 Packaging:

## 7.1 Packaging -Cover Tape

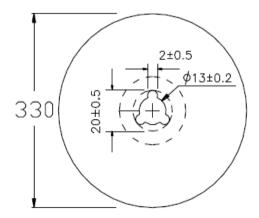


### 7.2 Packaging Quantity

TYPE	PCS/REEL
BPPM00090748	700

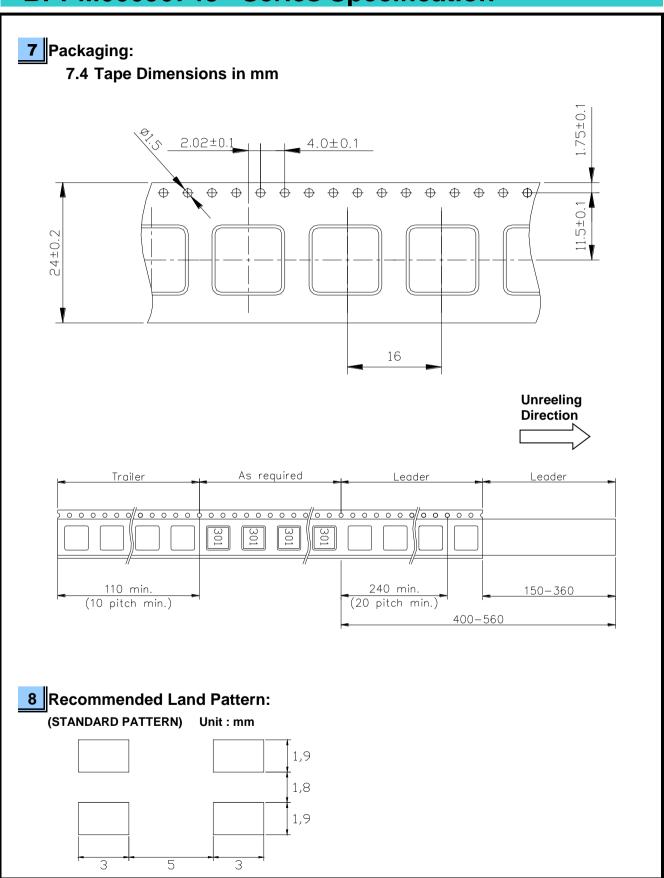
#### 7.3 Reel Dimensions

Unit: mm



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# 9 Note:

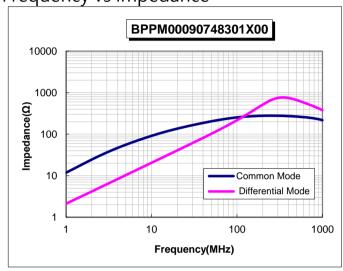
- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock or drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. The moisture sensitivity level (MSL) of products is classified as level 1.

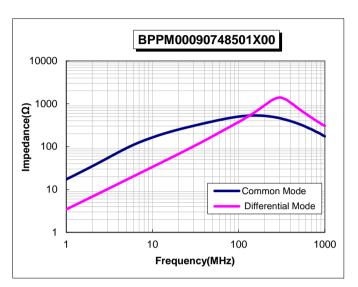
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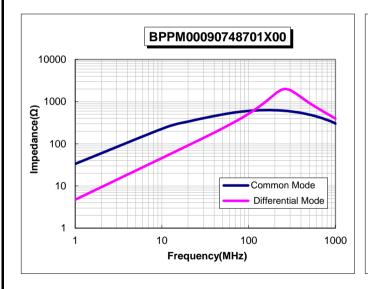


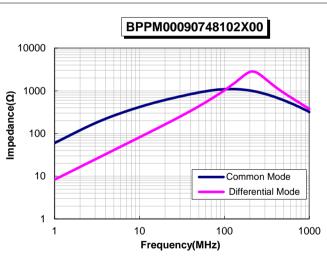
### TYPICAL ELECTRICAL CHARACTERISTICS

## Frequency vs impedance











### TYPICAL ELECTRICAL CHARACTERISTICS

## Frequency vs impedance

